

5A Low-Dropout Linear Regulator

Features

- Available in 1.5V, 1.8V, 2.5V, 3.3V version
- TO-252, TO-263 package
- Internal short circuit current limiting
- Internal over temperature protection
- Output current 5A

Applications

- Post regulation for switching DC/DC converter
- High efficiency linear regulator
- Battery powered instrumentation
- Motherboard

General Description

The G1084-XX is a low dropout linear regulator with a dropout of 1.3V at 5A of load current. It is available in three fixed voltages: 1.5V, 1.8V, 2.5V and 3.3V. Refer to the G1084 for the adjustable version.

The G1084-XX provides over temperature and over current protection circuits to prevent it from being damaged by abnormal operating conditions.

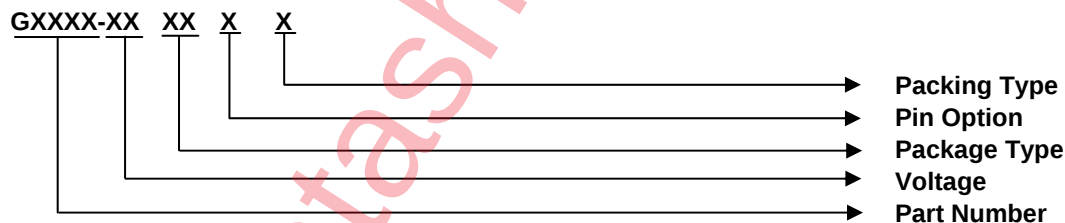
The G1084-XX is available in TO-252 and TO-263 packages. A minimum of 220μF tantalum electrolytic capacitor is required at the output to improve the transient response and stability.

Ordering Information

ORDER NUMBER	ORDER NUMBER (Pb free)	MARKING	TEMP. RANGE	PACKAGE	PIN OPTION		
					1	2	3
G1084-15T43U	G1084-15T43Uf	G1084-15	-40°C to +85°C	TO-252	GND	V _{OUT}	V _{IN}
G1084-18T43U	G1084-18T43Uf	G1084-18	-40°C to +85°C	TO-252	GND	V _{OUT}	V _{IN}
G1084-25T43U	G1084-25T43Uf	G1084-25	-40°C to +85°C	TO-252	GND	V _{OUT}	V _{IN}
G1084-33T43U	G1084-33T43Uf	G1084-33	-40°C to +85°C	TO-252	GND	V _{OUT}	V _{IN}
G1084-15T53U	G1084-15T53Uf	G1084-15	-40°C to +85°C	TO-263	GND	V _{OUT}	V _{IN}
G1084-18T53U	G1084-18T53Uf	G1084-18	-40°C to +85°C	TO-263	GND	V _{OUT}	V _{IN}
G1084-25T53U	G1084-25T53Uf	G1084-25	-40°C to +85°C	TO-263	GND	V _{OUT}	V _{IN}
G1084-33T53U	G1084-33T53Uf	G1084-33	-40°C to +85°C	TO-263	GND	V _{OUT}	V _{IN}

* For other package types and pin options, please contact us at sales@gmt.com.tw

Order Number Identification



PACKAGE TYPE

T4: TO-252

T5: TO-263

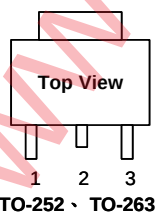
PIN OPTION

1 2 3
3: GND V_{OUT} V_{IN}

PACKING

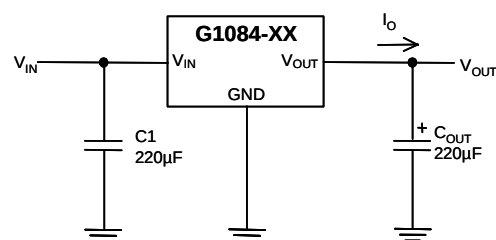
U: Tape & Reel

Package Type



Typical Application

[Note 4]: Type of C_{OUT}



**Absolute Maximum Ratings**

(Note 1)

Input Voltage	8V
Power Dissipation Internally Limited	(Note 2)
Maximum Junction Temperature	150°C
Storage Temperature Range	-65°C ≤ T _J ≤ +150°C
Reflow Temperature (soldering, 10sec)	260°C
Thermal Resistance Junction to Ambient	
TO-252 ⁽¹⁾	95°C/W
TO-263 ⁽¹⁾	92°C/W
Thermal Resistance Junction to Case	
TO-252	8°C/W
TO-263	6°C/W
ESD Rating (Human Body Model)	2kV

Note ⁽¹⁾: See Recommended Minimum Footprint**Operating Conditions**

(Note 1)

Input Voltage	2.2V~7V
Temperature Range	-40°C ≤ T _A ≤ 85°C

Electrical CharacteristicsV_{IN} = 5V, C_{IN} = C_{OUT} = 220μF, T_A = T_J = 25°C unless otherwise specified. (Note3)

PARAMETER	CONDITION	MIN	TYP	MAX	UNIT
Output Voltage	10mA ≤ I _{OUT} ≤ 5A	-2%	V _O	2%	V
Line Regulation	(V _{OUT} + 0.7V) ≤ V _{IN} ≤ 5.5V, I _{OUT} = 10mA	---	0.1	---	%
Load Regulation	G1084-18 V _{IN} = 3.8V, 10mA ≤ I _{OUT} ≤ 5A	---	1	---	%
	G1084-25 V _{IN} = 5V, 10mA ≤ I _{OUT} ≤ 5A				
	G1084-33 V _{IN} = 5V, 10mA ≤ I _{OUT} ≤ 5A				
Dropout Voltage	G1084-18 ΔV _{OUT} = 2%, I _{OUT} = 5A	---	1.6	---	V
	G1084-25 ΔV _{OUT} = 2%, I _{OUT} = 5A	---	1.3	---	
	G1084-33 ΔV _{OUT} = 2%, I _{OUT} = 5A	---	1.1	---	
Current Limit	(V _{IN} - V _{OUT}) = 2V	---	5.5	---	A
Short Circuit Current		---	1	---	A
Quiescent Current	G1084-18 V _{IN} = 5V	---	1.7	---	mA
	G1084-25 V _{IN} = 5V	---	2.1	---	
	G1084-33 V _{IN} = 5V	---	2.4	---	
Ripple Rejection	f = 120Hz, C _{OUT} = 10μF Tantalum, (V _{IN} - V _{OUT}) = 3V, I _{OUT} = 1A	---	50	---	dB
Thermal Shutdown	Junction Temperature	---	150	---	°C

Note 1: Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Conditions are conditions under which the device functions but the specifications might not be guaranteed. For guaranteed specifications and test conditions see the Electrical Characteristics.

Note2: The maximum power dissipation is a function of the maximum junction temperature, T_{Jmax}; total thermal resistance, θ_{JA}, and ambient temperature T_A. The maximum allowable power dissipation at any ambient temperature is T_{Jmax}-T_A / θ_{JA}. If this dissipation is exceeded, the die temperature will rise above 150°C and IC will go into thermal shutdown.

Note3: Low duty pulse techniques are used during test to maintain junction temperature as close to ambient as possible.

Note4: The type of output capacitor should be tantalum or aluminum.

Definitions**Dropout Voltage**

The input/output Voltage differential at which the regulator output no longer maintains regulation against further reductions in input voltage. Measured when the output drops 2% below its nominal value. Dropout voltage is affected by junction temperature, load current and minimum input supply requirements.

Line Regulation

The change in output voltage for a change in input voltage. The measurement is made under conditions of low dissipation or by using pulse techniques such that average chip temperature is not significantly affected.

Load Regulation

The change in output voltage for a change in load current at constant chip temperature. The measurement is made under conditions of low dissipation or by using pulse techniques such that average chip temperature is not significantly affected.

Maximum Power Dissipation

The maximum total device dissipation for which the regulator will operate within specifications.

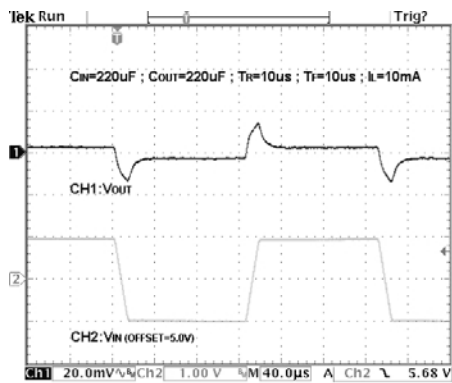
Quiescent Bias Current

Current which is used to operate the regulator chip and is not delivered to the load.

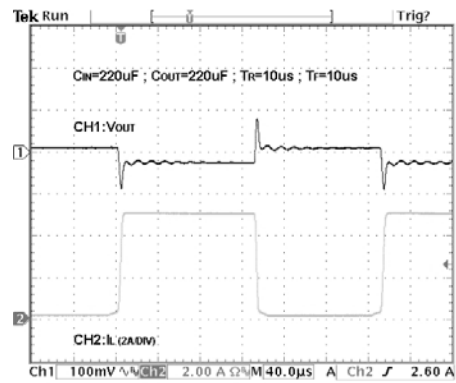
Typical Performance Characteristics

$V_{IN}-V_{OUT} = 3V$, $C_{IN} = 220\mu F$, $C_{OUT} = 220\mu F$, $T_A=25^\circ C$, unless otherwise noted.

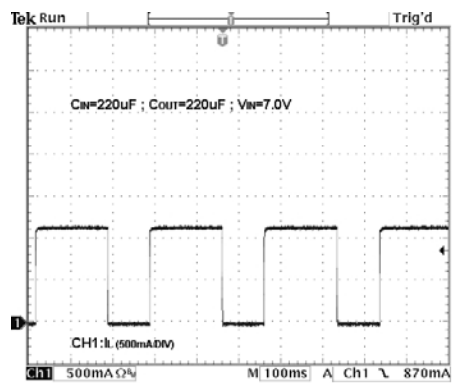
Line Transient Response



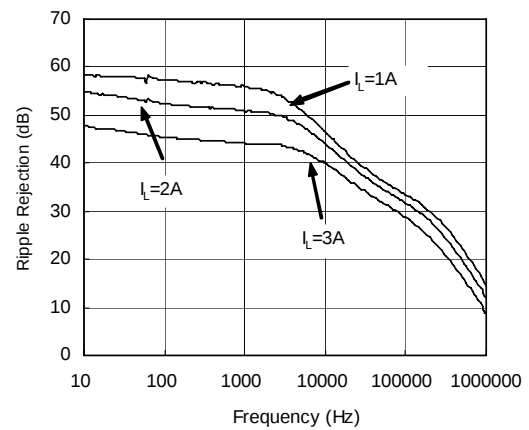
Load Transient Response



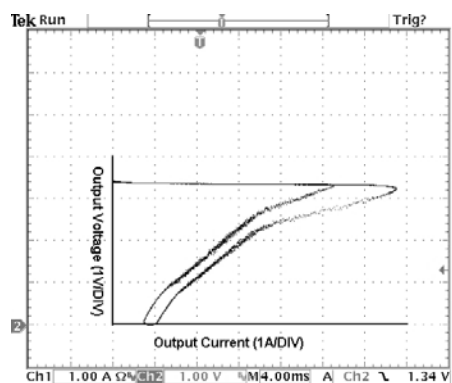
Short Circuit Current



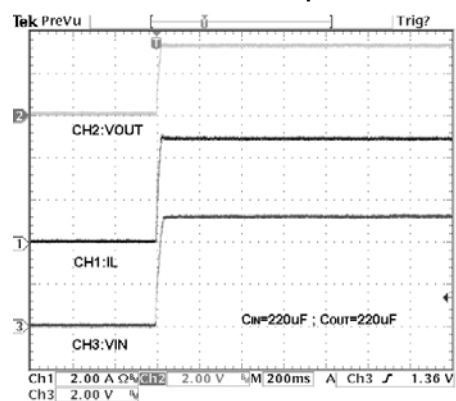
Ripple Rejection



G1084-33 Overcurrent Protection Characteristics

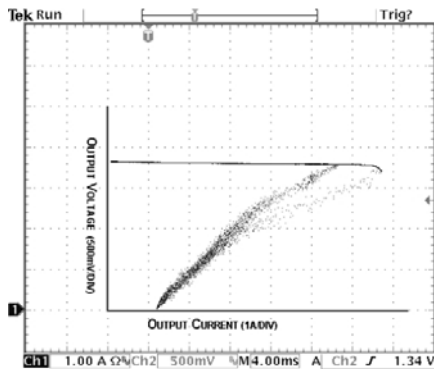


G1084 Start-up

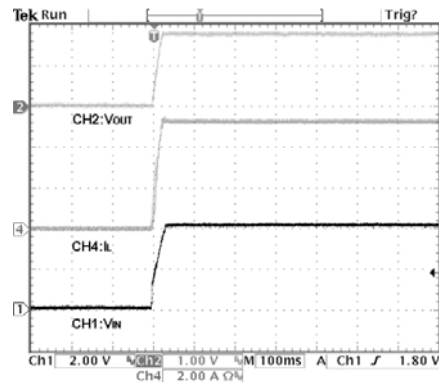


Typical Performance Characteristics (continued)

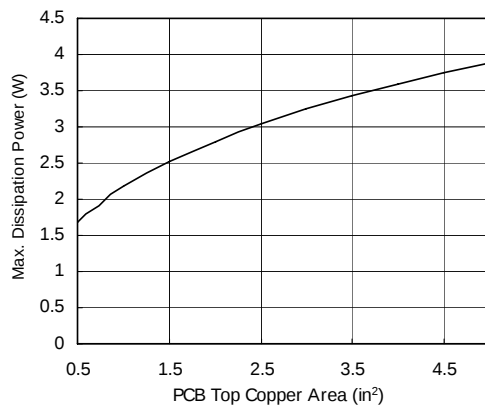
G1084-18 Overcurrent Protection Characteristics



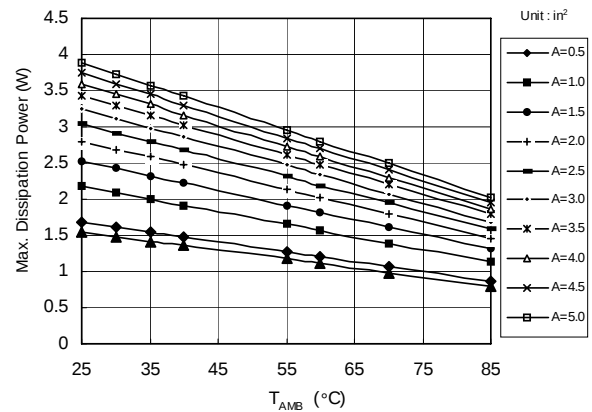
G1084-18 Start-up



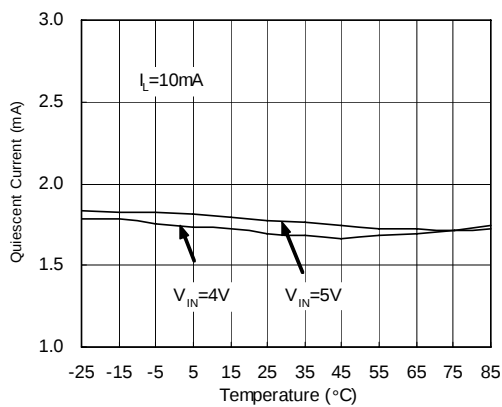
G1084 Max. Power Dissipation vs. PCB Top Copper Area



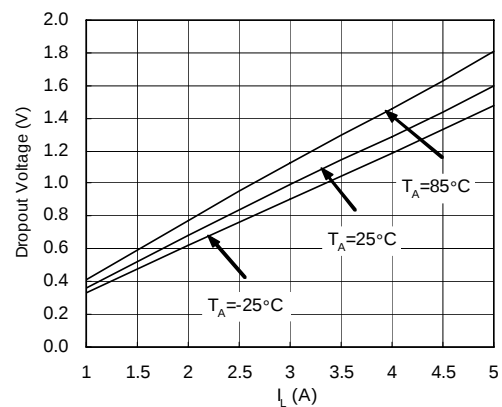
G1084 Max. Power Dissipation vs. T_{AMB}



G1084-18 Quiescent Current vs. Temperature

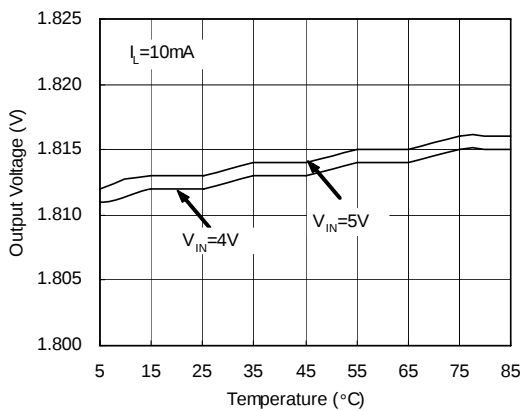
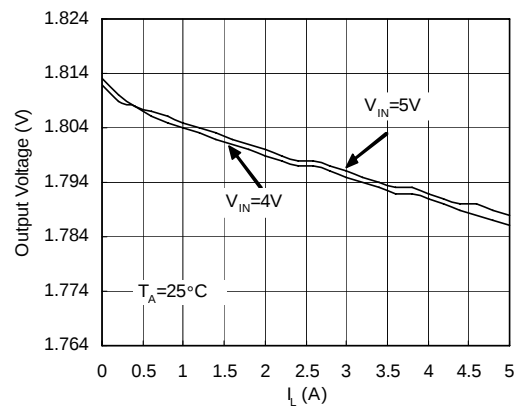
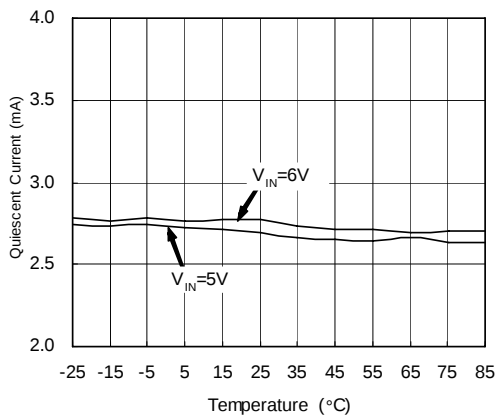
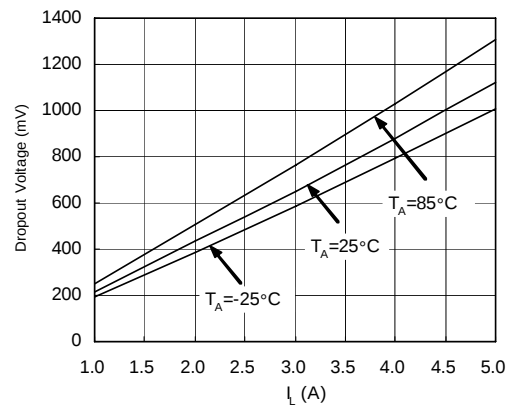
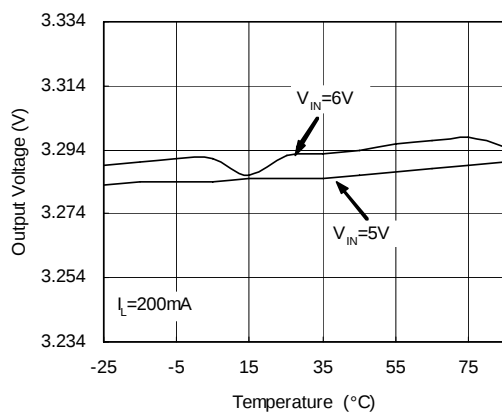
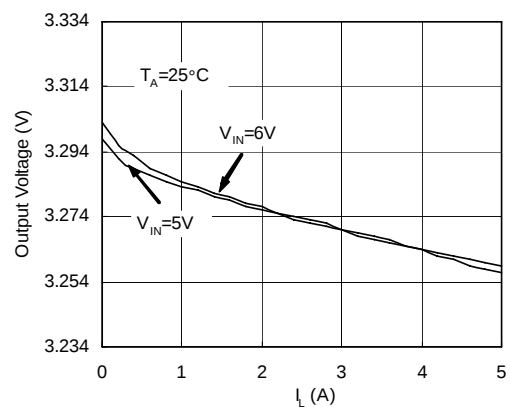


G1084-18 Dropout Voltage vs. I_L

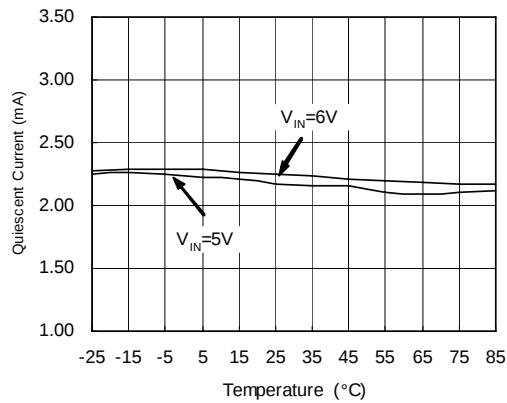
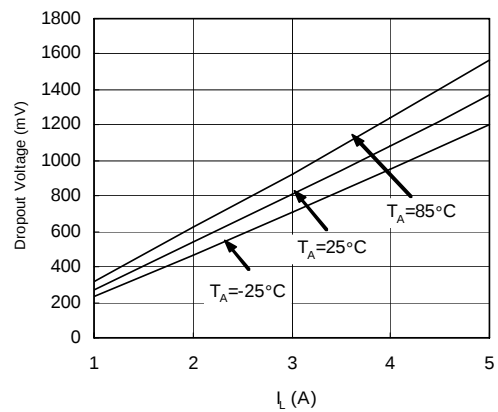
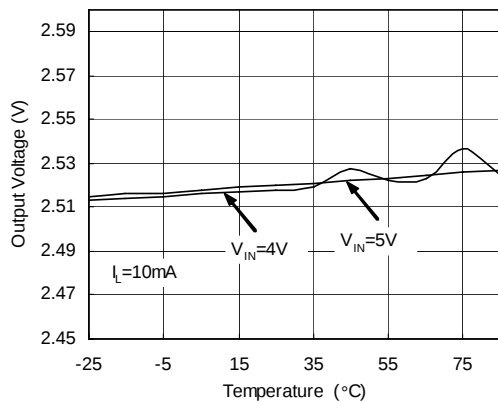
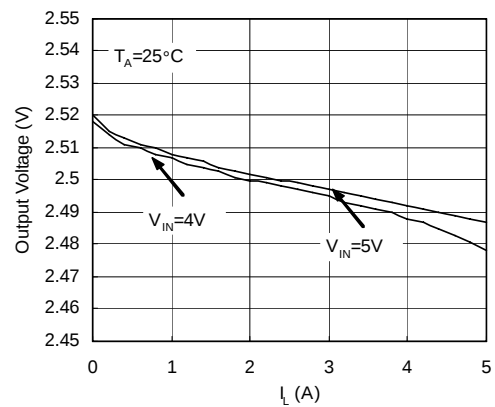




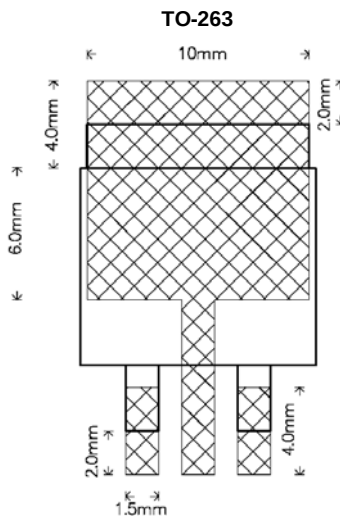
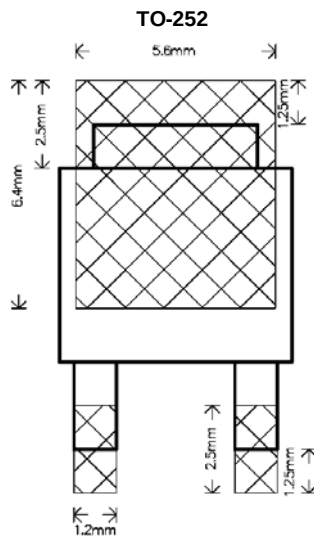
Typical Performance Characteristics (continued)

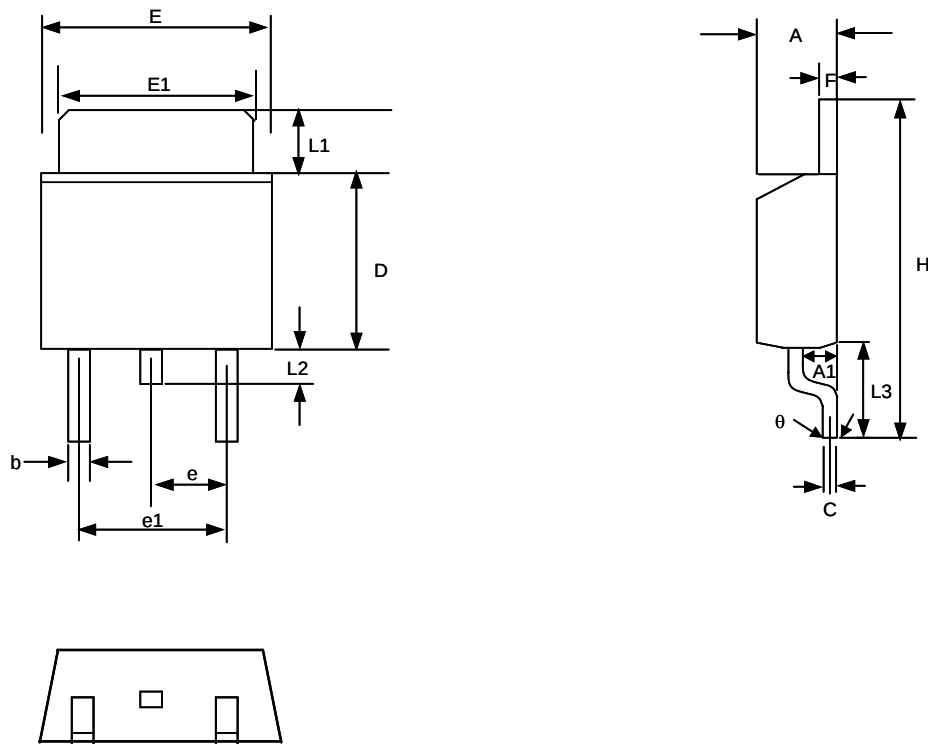
G1084-18 Output Voltage vs. Temperature**G1084-18 Output Voltage vs. I_L** **G1084-33 Quiescent Current vs. Temperature****G1084-33 Dropout Voltage vs. I_L** **G1084-33 Output Voltage vs. Temperature****G1084-33 Output Voltage vs. I_L** 

Typical Performance Characteristics (continued)

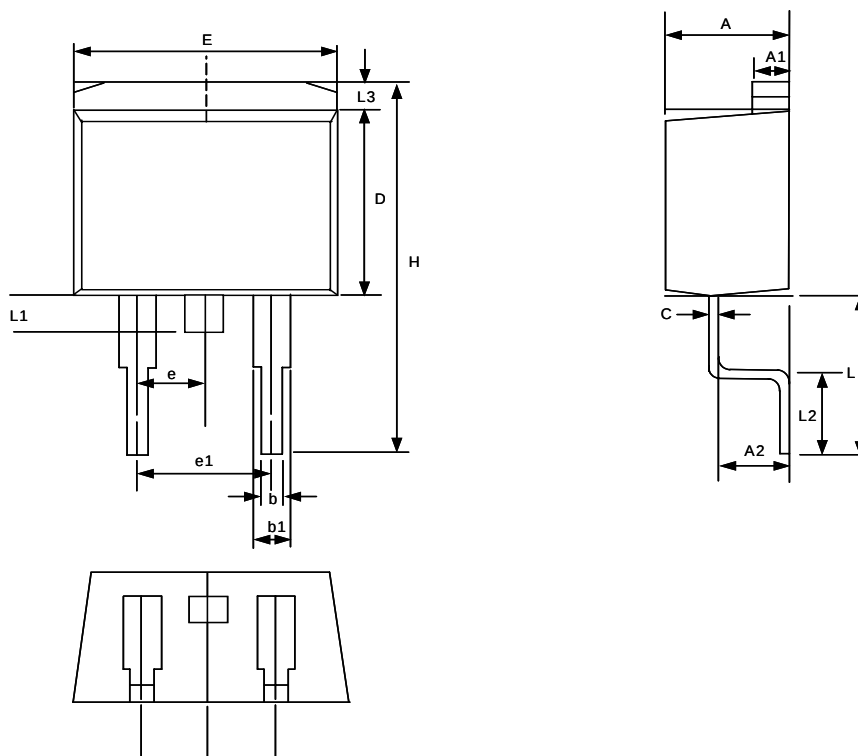
G1084-25 Quiescent Current vs. Temperature

G1084-25 Dropout Voltage vs. I_L

G1084-25-Output Voltage vs. Temperature

G1084-25 Output Voltage vs. I_L


Recommend Minimum Footprint



**Package Information****TO-252 (T4) Package**

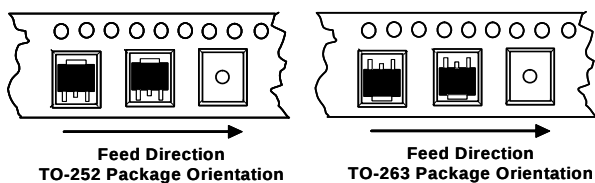
SYMBOL	MILLIMETER		INCH	
	MIN.	MAX.	MIN.	MAX.
A	2.19	2.38	0.086	0.094
A1	0.89	1.27	0.035	0.050
b	0.64	0.89	0.025	0.035
C	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
E	6.35	6.73	0.250	0.265
E1	5.21	5.46	0.205	0.215
e	2.26BSC		0.09BSC	
e1	3.96	5.18	0.156	0.204
F	0.46	0.58	0.018	0.023
L1	0.89	2.03	0.035	0.080
L2	0.64	1.02	0.025	0.040
L3	2.40	2.80	0.095	0.110
H	9.40	10.40	0.370	0.410
θ	0°	4°	0°	4°



TO-263 (T5) Package

SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	4.30	4.70	0.169	0.185
A1	1.22	1.32	0.048	0.055
A2	2.45	2.69	0.104	0.106
b	0.69	0.94	0.027	0.037
b1	1.22	1.40	0.048	0.055
C	0.36	0.56	0.014	0.022
D	8.64	9.652	0.340	0.380
E	9.70	10.54	0.382	0.415
e	2.29	2.79	0.090	0.110
e1	4.83	5.33	0.190	0.210
H	14.60	15.78	0.575	0.625
L	4.70	5.84	0.185	0.230
L1	1.20	1.778	0.047	0.070
L2	2.24	2.84	0.088	0.111
L3	1.40MAX		0.055MAX	

Taping Specification



PACKAGE	Q'TY/REEL
TO-252	2,500 ea
TO-263	800 ea

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